OSRAM OSTAR® Projection Compact

Compact light source with isolated heat sink for improved heat dissipation and high current chip technology for increased light output.









Applications

- Projection Home LED & Laser
- Projection Professional LED & Laser

Stage Lighting (LED & Laser)

Features:

- Package: white molded SMD ceramic package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.322, Cy = 0.639 acc. to CIE 1931 (● pure green)
- Corrosion Robustness Class: 3A
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)



Ordering Information		
Туре	Luminous Flux ¹⁾ $I_F = 1000 \text{ mA}$ Φ_V	Ordering Code
KP CSLNM1.F1-8N7P-A	400 630 lm	Q65113A1223



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min. max.	-40 °C 125 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 125 °C
Junction Temperature	T _j	max.	150 °C
Forward Current T _S = 25 °C	I _F	min. max.	40 mA 3000 mA
Forward Current pulsed D = 0.5; f = 240Hz; T _s = 25°C	 F pulse		4000 mA
Surge Current $t_p \le 50 \ \mu s; \ D = 0.1; \ T_s = 25 \ ^{\circ}C$	I _{FS}	max.	4500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V _{ESD}		8 kV
Reverse current 2)	I _R	max.	200 mA



-	$\overline{}$	H-	_		- 4	_	 - 1		
и	-	n	9	ro	\boldsymbol{c}	_	01	71	00
А			a	-		<u>_</u>	 -		CS

 I_F = 1000 mA; T_S = 25 °C

Parameter	Symbol		Values	
Chromaticity Coordinate 3)	Сх	typ.	0.322	
within $\lambda = 500 600 \text{ nm}$	Су	typ.	0.639	
Viewing angle at 50% $\rm I_{_{\rm V}}$	2φ	typ.	120 °	
Radiating surface	A_{color}	typ.	1.03 x 1.03 mm²	
Partial Flux acc. CIE 127:2007 $^{4)}$ I _F = 1000 mA	Ф _{Е/V, 120°}	typ.	0.76	
Forward Voltage 5)	V _F	min.	2.75 V	
$I_{\rm F} = 1000 \text{mA}$	·	typ.	3.00 V	
		max.	3.50 V	
Reverse voltage (ESD device)	V_{RESD}	min.	45 V	
Reverse voltage ²⁾ I _R = 20 mA	V_R	max.	1.2 V	
Real thermal resistance junction/solderpoint ⁶⁾	R _{thJS real}	typ.	4.1 K / W	
	thooreal	max.	4.9 K / W	
Electrical thermal resistance junction/solderpoint ⁶⁾	R _{thJS elec.}	typ.	2.9 K / W	
with efficiency η_e = 30 %	1100 0100.	max.	3.4 K / W	

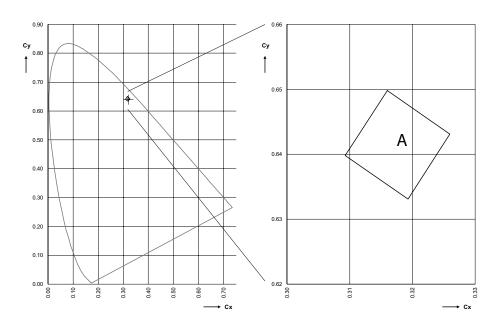


Brightness Groups		
Group	Luminous Flux 1)	Luminous Flux 1)
	$I_F = 1000 \text{ mA}$	$I_F = 1000 \text{ mA}$
	min.	max.
	Φ_{V}	Φ_{V}
8N	400 lm	450 lm
5P	450 lm	500 lm
6P	500 lm	560 lm
7P	560 lm	630 lm



Chromaticity Coordinate Groups 3)

within $\lambda = 500 ... 600 \text{ nm}$



Chromaticity Coordinate Groups 3)

Group	Cx	Су
А	0.3093	0.6398
	0.3160	0.6498
	0.3260	0.6431
	0.3193	0.6331

Group Name on Label

Example: 5P-A

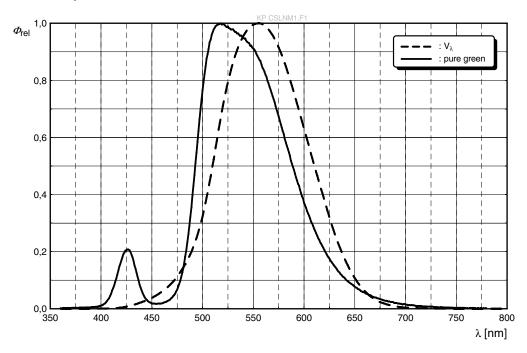
Brightness Color Chromaticity

5P A



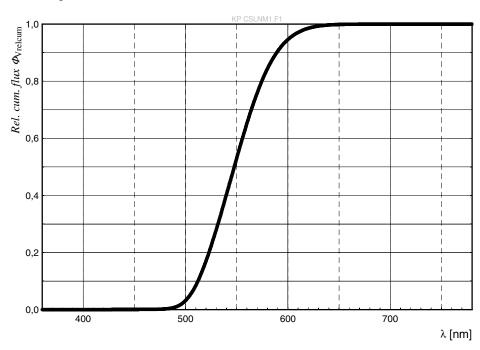
Relative Spectral Emission 4)

$$\Phi_{rel}$$
 = f (λ); I_F = 1000 mA; T_J = 25 °C



Relative cumulated Luminous Flux 4)

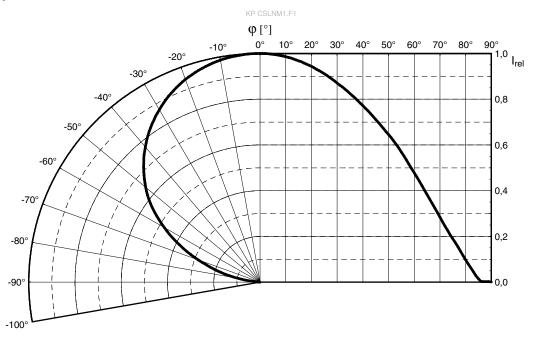
$$\Phi_{\text{Vrel-cum}} = f (\lambda); I_F = 1000 \text{ mA}; T_J = 25 \text{ °C}$$





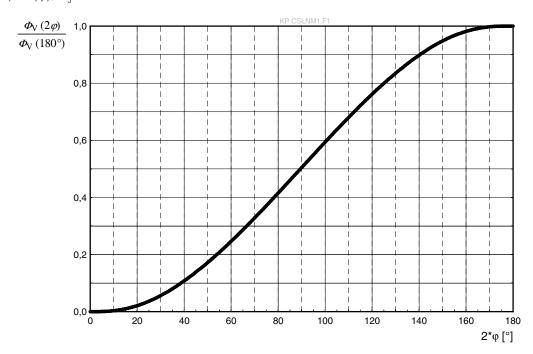
Radiation Characteristics 4)

$$I_{rel} = f(\phi); T_J = 25 °C$$



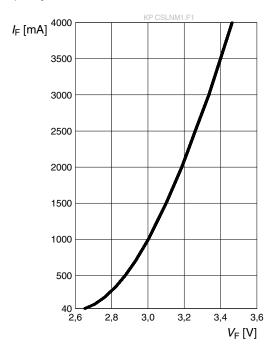
Relative Partial Flux 4)

 $\Phi_{v}(2\phi)/\Phi_{v}(180^{\circ}) = f(\phi); T_{J} = 25 {\circ}C$



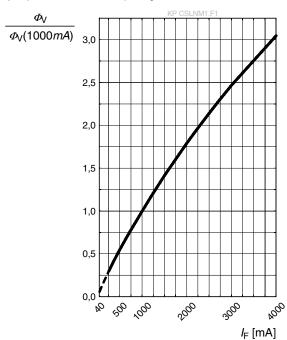
Forward current 4), 7)

$$I_F = f(V_F); T_J = 25 °C$$



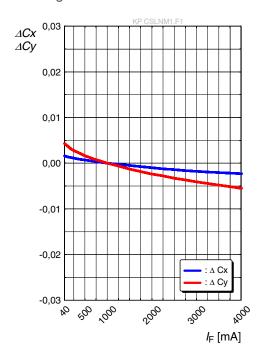
Relative Luminous Flux 4), 7)

$$\Phi_{V}/\Phi_{V}(1000 \text{ mA}) = f(I_{F}); T_{J} = 25 \text{ }^{\circ}\text{C}$$



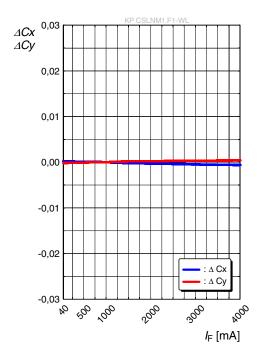
Chromaticity Coordinate Shift 4)

 ΔCx , $\Delta Cy = f(IF)$; $T_J = 25$ °C; full spectral range



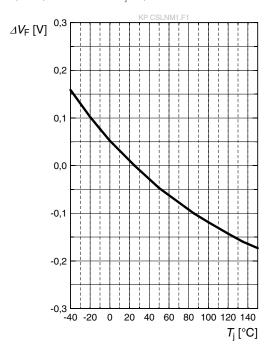
Chromaticity Coordinate Shift 4)

 Δ Cx, Δ Cy = f(IF); T_J = 25 °C; within λ = 500 ... 600 nm



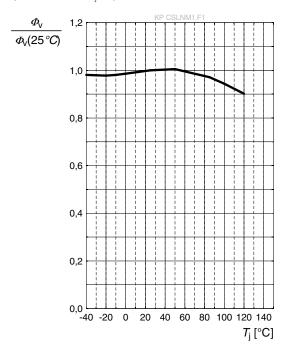
Forward Voltage 4)

$$\Delta V_{F} = V_{F} - V_{F}(25 \text{ °C}) = f(T_{i}); I_{F} = 1000 \text{ mA}$$



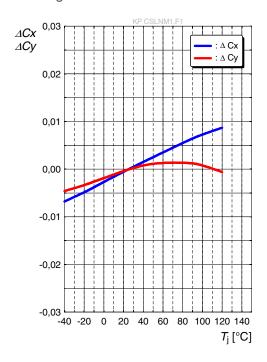
Relative Luminous Flux 4)

$$\Phi_{V}/\Phi_{V}(25 \text{ °C}) = f(T_{i}); I_{F} = 1000 \text{ mA}$$



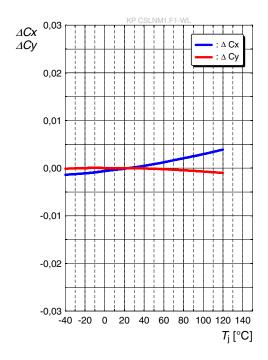
Chromaticity Coordinate Shift 4)

 ΔCx , $\Delta Cy = f(Tj)$; $I_F = 1000$ mA; full spectral range



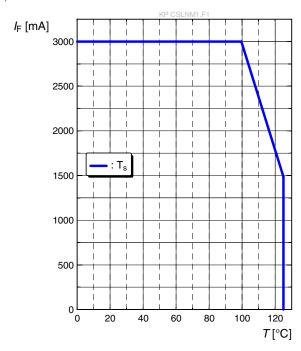
Chromaticity Coordinate Shift 4)

 ΔCx , $\Delta Cy = f(Tj)$; $I_F = 1000 \text{ mA}$; within $\lambda = 500 \dots 600 \text{ nm}$



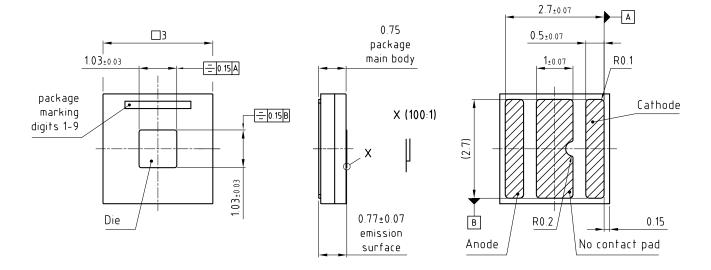
Max. Permissible Forward Current

 $I_F = f(T)$





Dimensional Drawing 8)



general tolerance ± 0.1 lead finish Au

C63062-A4312-A4 -03

Further Information:

Approximate Weight: 36.0 mg

Package marking: Cathode

Corrosion test: Class: 3A

Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

60068-2-43)

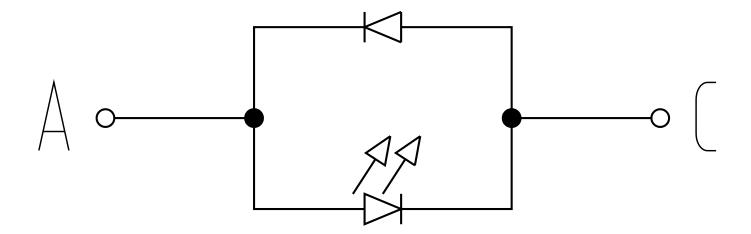
ESD advice: The device is protected by ESD device which is connected in parallel to the

Chip.

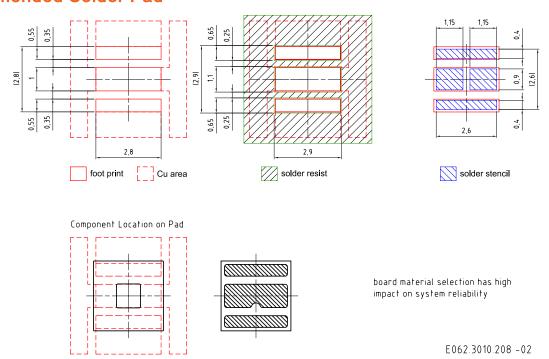


Electrical Internal Circuit

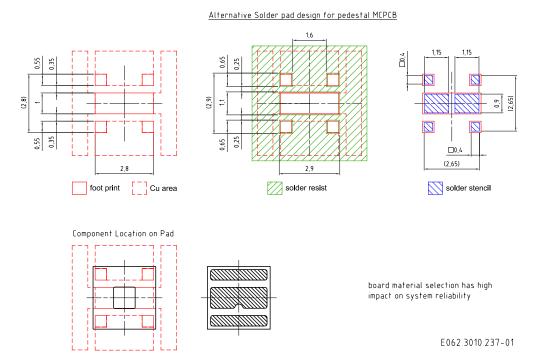
ESD Protection



Recommended Solder Pad 8)



Recommended Solder Pad 8)

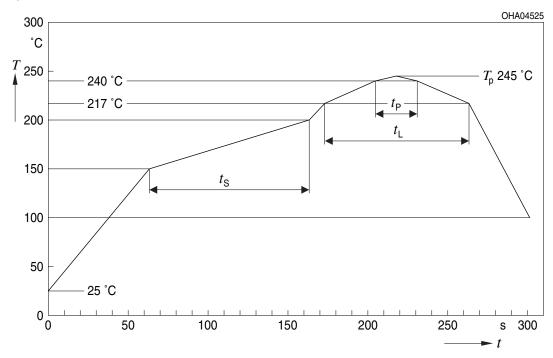


Board selection has high impact on system reliability. For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



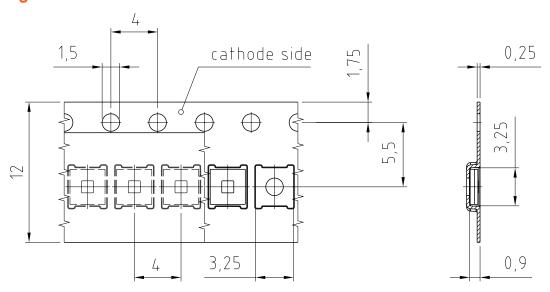
Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)			2	3	K/s
25 °C to 150 °C					
Time t _s	t_s	60	100	120	S
T_{Smin} to T_{Smax}					
Ramp-up rate to peak*)			2	3	K/s
T_{Smax} to T_{P}					
Liquidus temperature	T_{L}		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak	t _P	10	20	30	S
temperature T _P - 5 K					
Ramp-down rate*			3	6	K/s
T _P to 100 °C					
Time				480	S
25 °C to T _P					

All temperatures refer to the center of the package, measured on the top of the component



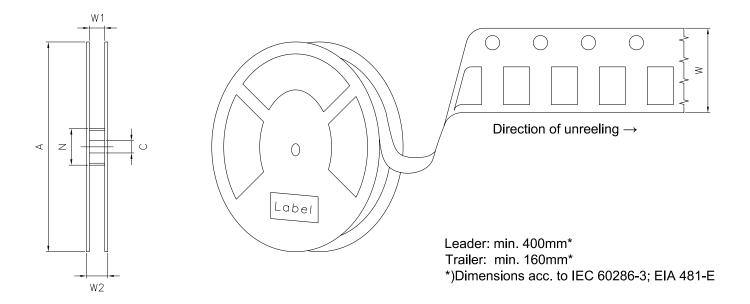
^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping 8)



C63062-A4312-B3-03

Tape and Reel 9)



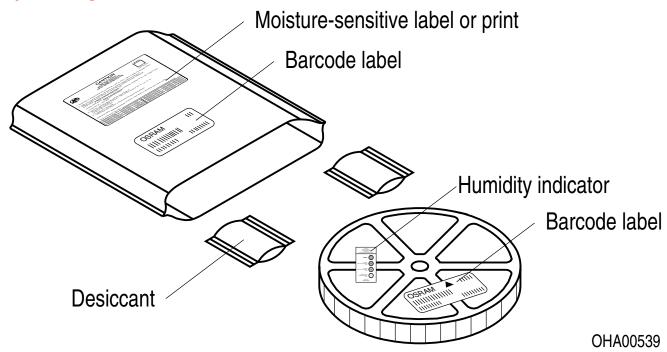
Reel Dimensions

Α	W	N_{\min}	W ₁	W_{2max}	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	1000

Barcode-Product-Label (BPL)



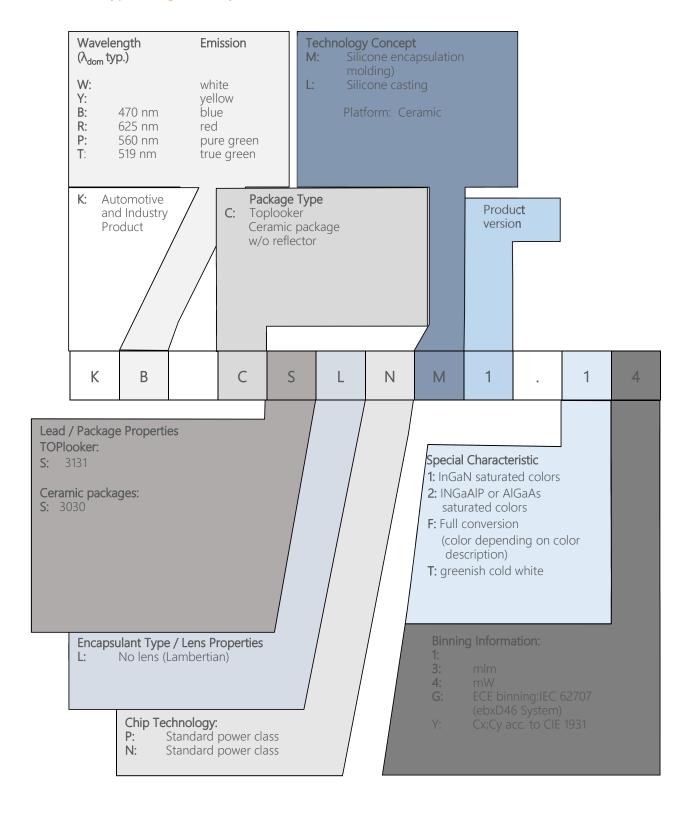
Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Type Designation System





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class moderate risk (exposure time 0.25 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Chromaticity coordinate groups: Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 6) **Thermal Resistance:** Rth max is based on statistic values (6σ) .
- 7) Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision	Revision History				
Version	Date	Change			
1.7	2019-01-07	Characteristics			
1.8	2020-07-17	Ordering Information			
1.9	2020-08-11	Characteristics Chromaticity Coordinate Groups			
1.10	2021-09-13	Applications			
1.10	2021-09-20	Derating (Diagrams)			
1.11	2022-01-04	Maximum Ratings			



Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

此产品符合欧盟 RoHS 指令的要求;

按照中国的相关法规和标准,不含有毒有害物质或元素。

